



Bi-directional ESD Protection Diode

Peak Pulse Power - 30 Watts
Reverse Working Voltage - 5V

Description

The H02X25V0BU is ultra low capacitance ESD designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge).

Features

- 1 Channel of ESD Protection (Bi-directional)
- Peak Pulse Power :Ppp = 30W (tp=8/20 us)
- Reverse Working Voltage : 5V
- Low Leakage Current
- Ultra low Capacitance : 0.2pF (Typ)
- IEC 61000-4-2 (ESD) :±10kV(Contact) / ±15kV(Air)

Applications

- Digital Visual Interface (DVI)
- Cellular Handsets & Accessories
- Display / USB / MDDI Ports
- RF Circuits
- PCI Express

Mechanical Data

- Case: DFN1006 Package
- Case Material: "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Component in accordance to RoHS
- Halogen Free

Note: Products with logo  or  are made by HY Electronic (Cayman) Limited.

Ordering Information

- Package :DFN1006
- Reel Size :7 (inches)
- Quantity Per Reel :10,000/Tape & Reel
- Quantity One Box :60,000/Tape & Reel
- Quantity One Carton :600,000/Tape & Reel

Marking Information



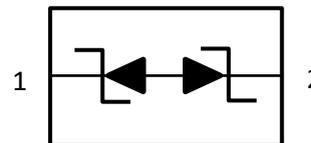
"S"=Product Type Marking Code

Package Outline



DFN1006 Top View

Device Schematic & PIN Configuration



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Absolute Ratings

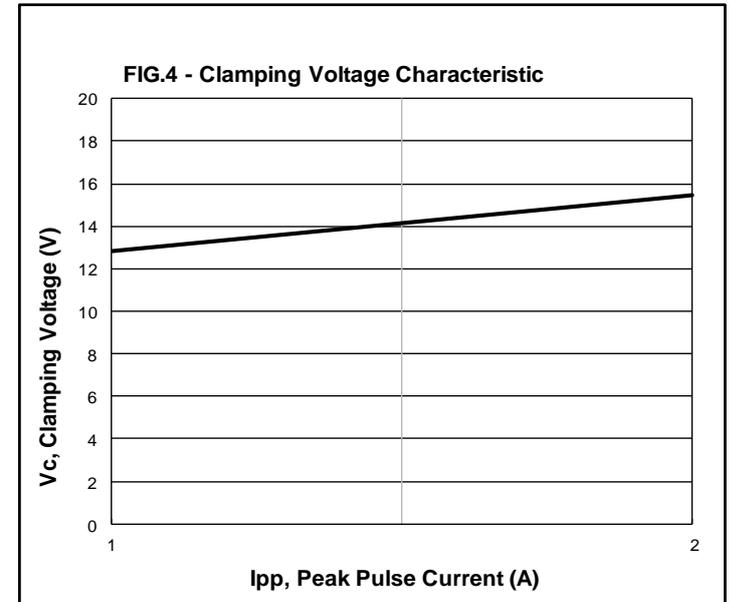
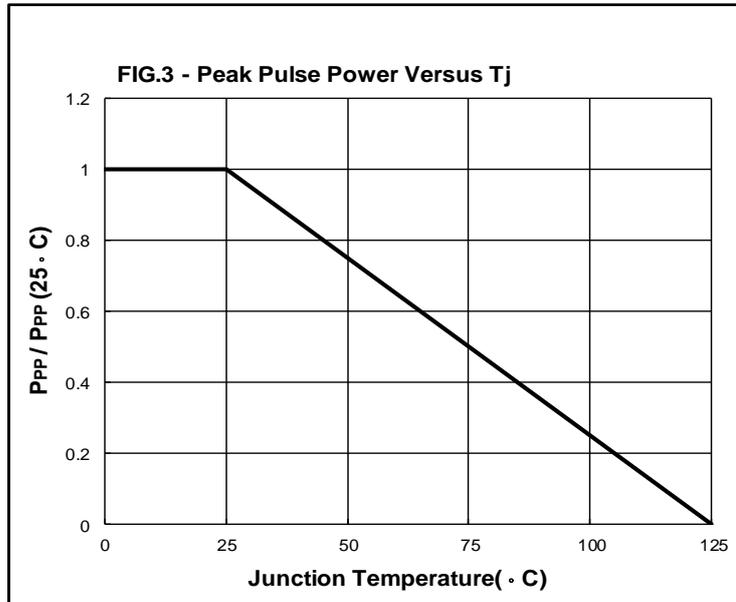
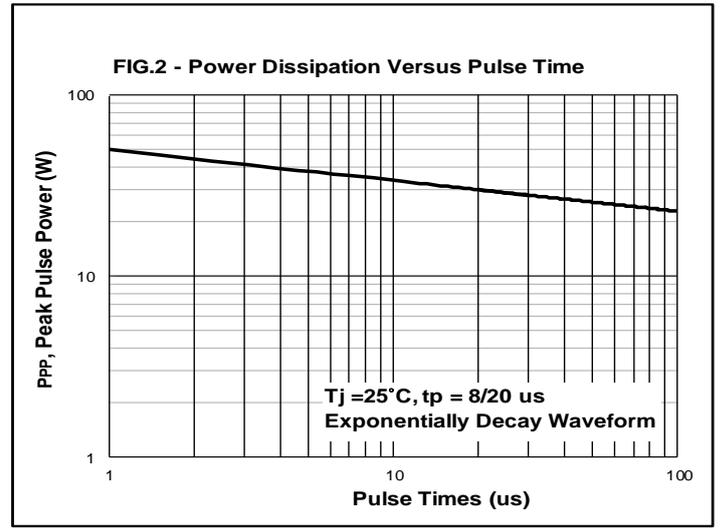
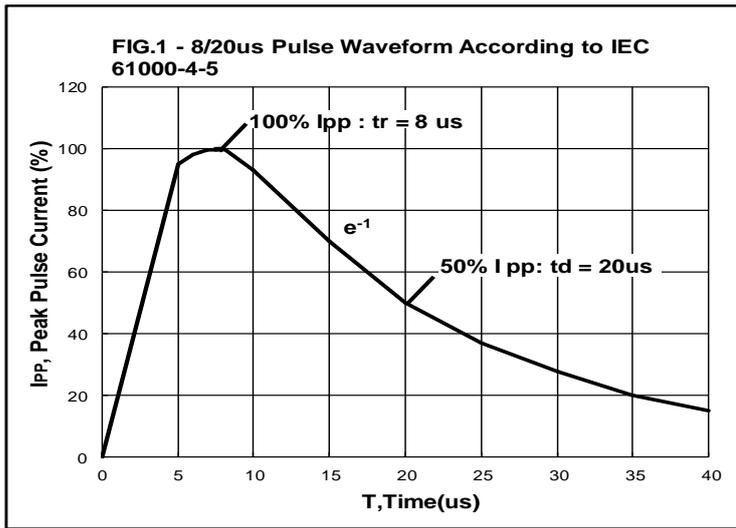
Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation (8/20 us)	P _{PP}	30	W
Peak Pulse Current (8/20 us)	I _{PP}	2	A
ESD Protection- Contact (Standard IEC 61000-4-2)	V _{ESD}	±10	k V
ESD Protection- Air (Standard IEC 61000-4-2)		±15	
Operating Temperature Range	T _J	-55 to +125	° C
Storage Temperature Range	T _{STG}	-55 to +150	° C
Soldering Temperature, t max =10s	T _L	260	° C

Electrical Characteristics

Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Reverse Working Voltage	---	V _{RWM}	-	-	5	V
Reverse Breakdown Voltage	I _T = 1mA	V _B	6	-	-	V
Reverse Current	V _R = 5V	I _R	-	-	0.1	uA
Reverse Clamping Voltage	I _{PP} = 1A (8/20μs)	V _C	-	-	13	V
	I _{PP} = 2A (8/20μs)		-	-	16	
Junction Capacitance	V _R = 0V, F = 1MHz	C _j	-	0.2	0.3	p F

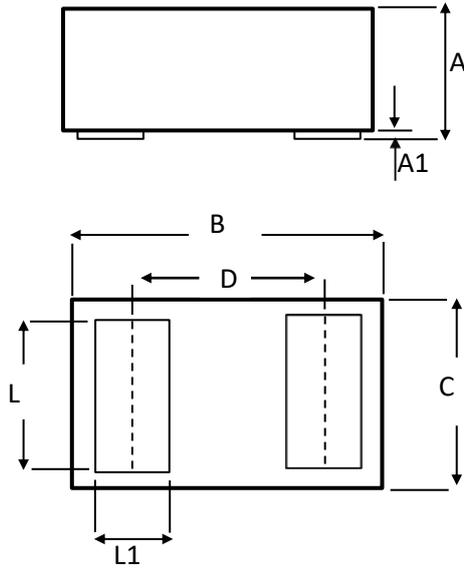


Rating and Characteristic Curves





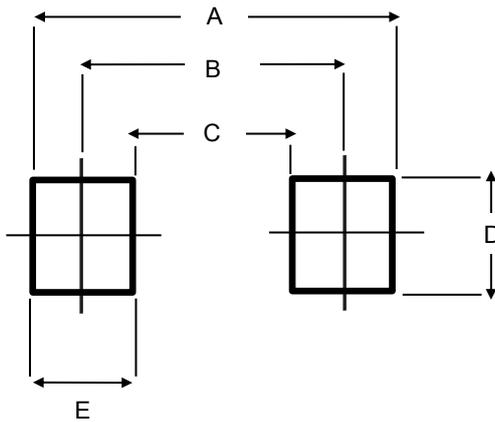
Package Outline Dimensions



DFN1006 Package		
Dim	Min	Max
A	0.45	0.55
A1	0.01(Typ)	
B	0.95	1.05
C	0.55	0.65
D	0.65(Typ)	
L	0.45	0.55
L1	0.30	0.40

Dimensions in mm

Suggested Soldering Pad Layout



Dim.	Value
A	1.25
B	0.75
C	0.25
D	0.70
E	0.50

All Dimensions in mm



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